

**GENERAL DESCRIPTION**

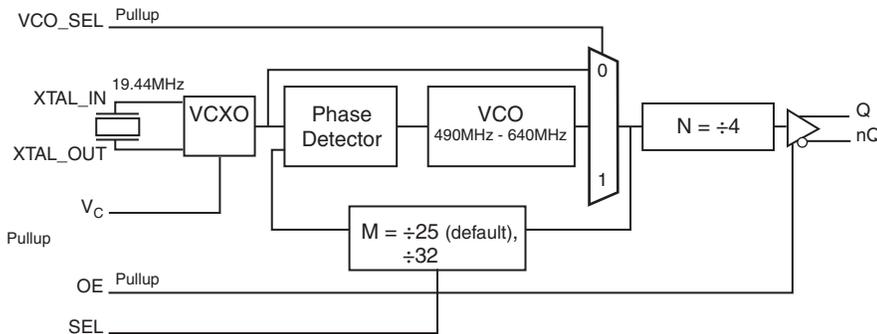


The ICS813321-04 is a two stage device – a VCXO followed by a FemtoClock™ PLL. The FemtoClock PLL can multiply the crystal frequency of the VCXO up to a range of 122MHz to 160MHz, with a random rms phase jitter of less than 1ps (1.875MHz – 20MHz). This phase jitter performance meets the requirements of 1Gb/10Gb Ethernet, 1Gb, 2Gb, 4Gb and 10Gb Fibre Channel, and SONET up to OC48.

**FEATURES**

- One 3.3V or 2.5V LVPECL output pair
- Crystal operating frequency range: 14MHz - 20MHz
- VCO range: 490MHz - 640MHz
- Output frequency range: 122MHz - 160MHz
- VCXO pull range: ±50ppm (typical APR) @ 3.3V
- Supports the following applications (among others): SONET, Ethernet, Fibre Channel
- RMS phase jitter @ 156.25MHz (1.875MHz - 20MHz): 0.53ps (typical) @ 3.3V
- Supply voltage modes:  
 $V_{cc}/V_{cco}$   
 3.3V/3.3V  
 3.3V/2.5V  
 2.5V/2.5V
- 0°C to 70°C ambient operating temperature
- Available in both standard (RoHS 5) and lead-free (RoHS 6) packages

**BLOCK DIAGRAM**



**PIN ASSIGNMENT**

|      |   |    |          |
|------|---|----|----------|
| nc   | 1 | 16 | VCO_SEL  |
| Vcco | 2 | 15 | nc       |
| Q    | 3 | 14 | OE       |
| nQ   | 4 | 13 | SEL      |
| VEE  | 5 | 12 | Vc       |
| nc   | 6 | 11 | nc       |
| VccA | 7 | 10 | XTAL_IN  |
| Vcc  | 8 | 9  | XTAL_OUT |

**ICS813321-04**  
**16-Lead TSSOP**  
 4.4mm x 5.0mm x 0.92mm  
 package body  
**G Package**  
 Top View

TABLE 1. PIN DESCRIPTIONS

| Νομ βερ      | Νομ ε             | Τυπε   |          | Δεσχηπαιον   |
|--------------|-------------------|--------|----------|--|
| 1, 6, 11, 15 | nc                | Unused |          | No connect.  |
| 2            | V <sub>CCO</sub>  | Power  |          | Output supply pin.   |
| 3, 4         | Q, nQ             | Output |          | Differential clock outputs. LVPECL interface levels.   |
| 5            | V <sub>EE</sub>   | Power  |          | Negative supply pin.   |
| 7            | V <sub>CCA</sub>  | Power  |          | Analog supply pin.   |
| 8            | V <sub>CC</sub>   | Power  |          | Core supply pin.   |
| 9, 10        | XTAL_OUT, XTAL_IN | Input  |          | Crystal oscillator interface. XTAL_IN is the input, XTAL_OUT is the output.  |
| 12           | V <sub>C</sub>    | Input  |          | VCXO control voltage input.  |
| 13           | SEL               | Input  | Pulldown | Select pin. LVCMOS/LVTTL interface levels. See Table 3.  |
| 14           | OE                | Input  | Pullup   | Output enable pin. When HIGH, the output is active. When LOW, the output is in a high impedance state. LVCMOS/LVTTL interface. |
| 16           | VCO_SEL           | Input  | Pullup   | VCO select pin. LVCMOS/LVTTL interface levels.   |

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics Table, for typical values.

TABLE 2. PIN CHARACTERISTICS

| Symbol                | Parameter               | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------------|-------------------------|-----------------|---------|---------|---------|-------|
| C <sub>IN</sub>       | Input Capacitance       |                 |         | 4       |         | pF    |
| R <sub>PULLUP</sub>   | Input Pullup Resistor   |                 |         | 51      |         | kΩ    |
| R <sub>PULLDOWN</sub> | Input Pulldown Resistor |                 |         | 51      |         | kΩ    |

TABLE 3. SEL FUNCTION TABLE

| Control Input | M             |
|---------------|---------------|
| SEL           |               |
| 0             | ÷25 (defalut) |
| 1             | ÷32           |

**ABSOLUTE MAXIMUM RATINGS**

|  |                          |
|--|--------------------------|
| Supply Voltage, $V_{CC}$                 | 4.6V                     |
| Inputs, $V_I$                            | -0.5V to $V_{CC} + 0.5V$ |
| Outputs, $I_O$ (LVPECL)                  |                          |
| Continuous Current                       | 50mA                     |
| Surge Current                            | 100mA                    |
| Package Thermal Impedance, $\theta_{JA}$ | 92.4°C/W (0 mps)         |
| Storage Temperature, $T_{STG}$           | -65°C to 150°C           |

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 4A. POWER SUPPLY DC CHARACTERISTICS,  $V_{CC} = V_{CCO} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol    | Parameter             | Test Conditions | Minimum         | Typical | Maximum  | Units |
|-----------|-----------------------|-----------------|-----------------|---------|----------|-------|
| $V_{CC}$  | Core Supply Voltage   |                 | 3.135           | 3.3     | 3.465    | V     |
| $V_{CCA}$ | Analog Supply Voltage |                 | $V_{CC} - 0.10$ | 3.3     | $V_{CC}$ | V     |
| $V_{CCO}$ | Output Supply Voltage |                 | 3.135           | 3.3     | 3.465    | V     |
| $I_{CCA}$ | Analog Supply Current |                 |                 |         | 10       | mA    |
| $I_{EE}$  | Power Supply Current  |                 |                 |         | 130      | mA    |

**TABLE 4B. POWER SUPPLY DC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{CCO} = 2.5V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol    | Parameter             | Test Conditions | Minimum         | Typical | Maximum  | Units |
|-----------|-----------------------|-----------------|-----------------|---------|----------|-------|
| $V_{CC}$  | Core Supply Voltage   |                 | 3.135           | 3.3     | 3.465    | V     |
| $V_{CCA}$ | Analog Supply Voltage |                 | $V_{CC} - 0.10$ | 3.3     | $V_{CC}$ | V     |
| $V_{CCO}$ | Output Supply Voltage |                 | 2.375           | 2.5     | 2.625    | V     |
| $I_{CCA}$ | Analog Supply Current |                 |                 |         | 10       | mA    |
| $I_{EE}$  | Power Supply Current  |                 |                 |         | 130      | mA    |

**TABLE 4C. POWER SUPPLY DC CHARACTERISTICS,  $V_{CC} = V_{CCO} = 2.5V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol    | Parameter             | Test Conditions | Minimum         | Typical | Maximum  | Units |
|-----------|-----------------------|-----------------|-----------------|---------|----------|-------|
| $V_{CC}$  | Core Supply Voltage   |                 | 2.375           | 2.5     | 2.625    | V     |
| $V_{CCA}$ | Analog Supply Voltage |                 | $V_{CC} - 0.10$ | 2.5     | $V_{CC}$ | V     |
| $V_{CCO}$ | Output Supply Voltage |                 | 2.375           | 2.5     | 2.625    | V     |
| $I_{CCA}$ | Analog Supply Current |                 |                 |         | 10       | mA    |
| $I_{EE}$  | Power Supply Current  |                 |                 |         | 125      | mA    |

TABLE 4D. LVCMOS / LVTTTL DC CHARACTERISTICS,  $T_A = 0^\circ\text{C}$  TO  $70^\circ\text{C}$ 

| Symbol   | Parameter          | Test Conditions  | Minimum | Typical | Maximum        | Units         |
|----------|--------------------|--|---------|---------|----------------|---------------|
| $V_{IH}$ | Input High Voltage | $V_{CC} = 3.3\text{V}$   | 2       |         | $V_{CC} + 0.3$ | V             |
|          |                    | $V_{CC} = 2.5\text{V}$   | 1.7     |         | $V_{CC} + 0.3$ | V             |
| $V_{IL}$ | Input Low Voltage  | $V_{CC} = 3.3\text{V}$   | -0.3    |         | 0.8            | V             |
|          |                    | $V_{CC} = 2.5\text{V}$   | -0.3    |         | 0.7            | V             |
| $I_{IH}$ | Input High Current | OE,<br>VCO_SEL<br>$V_{CC} = V_{IN} = 3.465\text{V}$ or $2.625\text{V}$               |         |         | 5              | $\mu\text{A}$ |
|          |                    | SEL<br>$V_{CC} = V_{IN} = 3.465\text{V}$ or $2.625\text{V}$                          |         |         | 150            | $\mu\text{A}$ |
| $I_{IL}$ | Input Low Current  | OE,<br>VCO_SEL<br>$V_{CC} = 3.465\text{V}$ or $2.625\text{V}$ , $V_{IN} = 0\text{V}$ | -150    |         |                | $\mu\text{A}$ |
|          |                    | SEL<br>$V_{CC} = 3.465\text{V}$ or $2.625\text{V}$ , $V_{IN} = 0\text{V}$            | -5      |         |                | $\mu\text{A}$ |

TABLE 4E. LVPECL DC CHARACTERISTICS,  $V_{CC} = V_{CCO} = 3.3\text{V} \pm 5\%$ ,  $V_{EE} = 0\text{V}$ ,  $T_A = 0^\circ\text{C}$  TO  $70^\circ\text{C}$ 

| Symbol      | Parameter                         | Test Conditions | Minimum         | Typical | Maximum         | Units |
|-------------|-----------------------------------|-----------------|-----------------|---------|-----------------|-------|
| $V_{OH}$    | Output High Voltage; NOTE 1       |                 | $V_{CCO} - 1.4$ |         | $V_{CCO} - 0.9$ | V     |
| $V_{OL}$    | Output Low Voltage; NOTE 1        |                 | $V_{CCO} - 2.0$ |         | $V_{CCO} - 1.7$ | V     |
| $V_{SWING}$ | Peak-to-Peak Output Voltage Swing |                 | 0.6             |         | 1.0             | V     |

NOTE 1: Outputs terminated with  $50\Omega$  to  $V_{CCO} - 2\text{V}$ .TABLE 4F. LVPECL DC CHARACTERISTICS,  $V_{CC} = 3.3\text{V} \pm 5\%$  OR  $2.5\text{V} \pm 5\%$ ,  $V_{CCO} = 2.5\text{V} \pm 5\%$ ,  $V_{EE} = 0\text{V}$ ,  $T_A = 0^\circ\text{C}$  TO  $70^\circ\text{C}$ 

| Symbol      | Parameter                         | Test Conditions | Minimum         | Typical | Maximum         | Units |
|-------------|-----------------------------------|-----------------|-----------------|---------|-----------------|-------|
| $V_{OH}$    | Output High Voltage; NOTE 1       |                 | $V_{CCO} - 1.4$ |         | $V_{CCO} - 0.9$ | V     |
| $V_{OL}$    | Output Low Voltage; NOTE 1        |                 | $V_{CCO} - 2.0$ |         | $V_{CCO} - 1.5$ | V     |
| $V_{SWING}$ | Peak-to-Peak Output Voltage Swing |                 | 0.4             |         | 1.0             | V     |

NOTE 1: Outputs terminated with  $50\Omega$  to  $V_{CCO} - 2\text{V}$ .

**TABLE 5A. AC CHARACTERISTICS,  $V_{CC} = V_{CCO} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol               | Parameter                                | Test Conditions              | Minimum | Typical | Maximum | Units |
|----------------------|--|------------------------------|---------|---------|---------|-------|
| $f_{OUT}$            | Output Frequency                         | VCO_SEL = 1                  | 122     |         | 160     | MHz   |
| $f_{jit}(\emptyset)$ | RMS Phase Jitter, (Random);<br>NOTE 1, 2 | 155.52MHz (1.875MHz - 20MHz) |         | 0.53    |         | ps    |
| $f_{VCO}$            | PLL VCO Lock Range                       |                              | 490     |         | 640     | MHz   |
| $t_R / t_F$          | Output Rise/Fall Time                    | 20% to 80%                   | 250     |         | 600     | ps    |
| odc                  | Output Duty Cycle                        |                              | 48      |         | 52      | %     |

NOTE 1: Phase jitter using a crystal interface.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

**TABLE 5B. AC CHARACTERISTICS,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{CCO} = 2.5V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol               | Parameter                                | Test Conditions              | Minimum | Typical | Maximum | Units |
|----------------------|--|------------------------------|---------|---------|---------|-------|
| $f_{OUT}$            | Output Frequency                         | VCO_SEL = 1                  | 122     |         | 160     | MHz   |
| $f_{jit}(\emptyset)$ | RMS Phase Jitter, (Random);<br>NOTE 1, 2 | 155.52MHz (1.875MHz - 20MHz) |         | 0.64    |         | ps    |
| $f_{VCO}$            | PLL VCO Lock Range                       |                              | 490     |         | 640     | MHz   |
| $t_R / t_F$          | Output Rise/Fall Time                    | 20% to 80%                   | 250     |         | 600     | ps    |
| odc                  | Output Duty Cycle                        |                              | 48      |         | 52      | %     |

NOTE 1: Phase jitter using a crystal interface.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

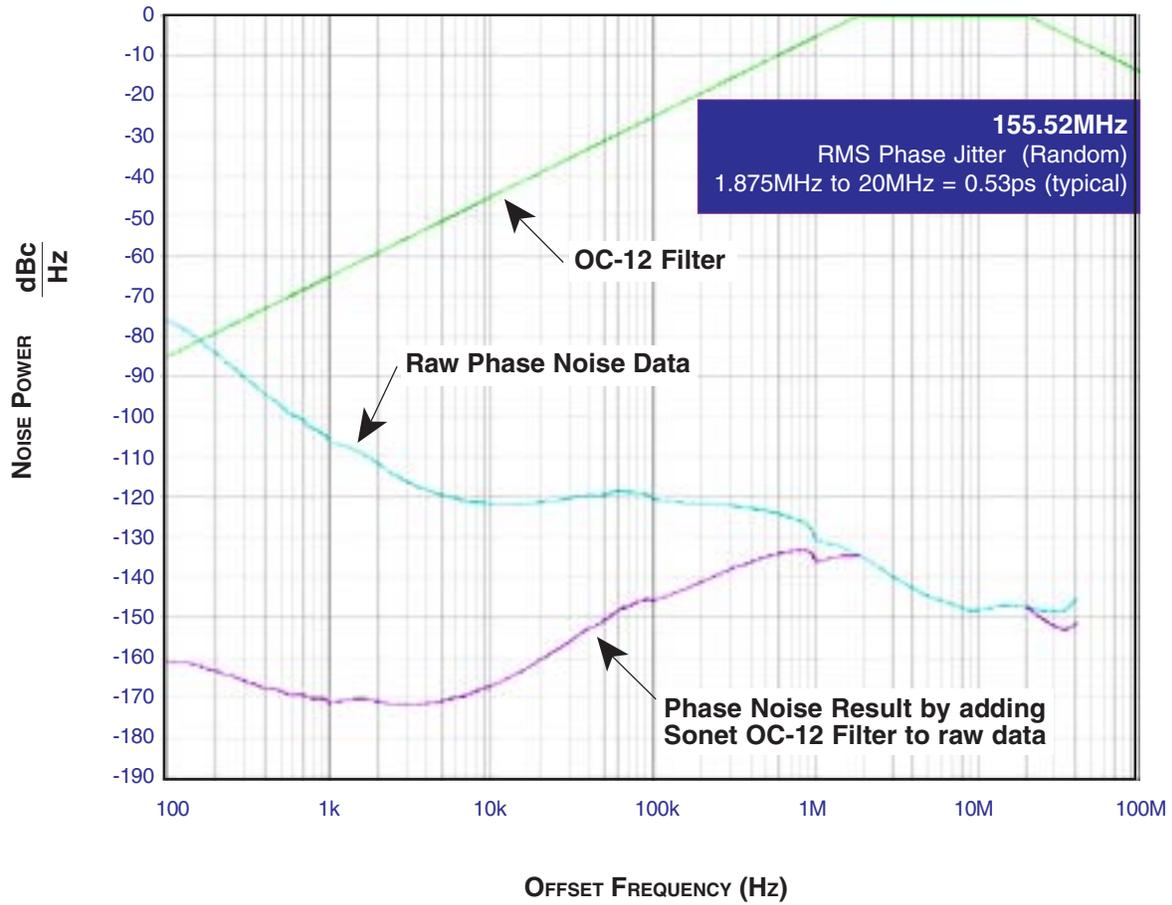
**TABLE 5C. AC CHARACTERISTICS,  $V_{CC} = V_{CCO} = 2.5V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$** 

| Symbol               | Parameter                                | Test Conditions              | Minimum | Typical | Maximum | Units |
|----------------------|--|------------------------------|---------|---------|---------|-------|
| $f_{OUT}$            | Output Frequency                         | VCO_SEL = 1                  | 122     |         | 160     | MHz   |
| $f_{jit}(\emptyset)$ | RMS Phase Jitter, (Random);<br>NOTE 1, 2 | 155.52MHz (1.875MHz - 20MHz) |         | 0.53    |         | ps    |
| $f_{VCO}$            | PLL VCO Lock Range                       |                              | 490     |         | 640     | MHz   |
| $t_R / t_F$          | Output Rise/Fall Time                    | 20% to 80%                   | 250     |         | 600     | ps    |
| odc                  | Output Duty Cycle                        |                              | 48      |         | 52      | %     |

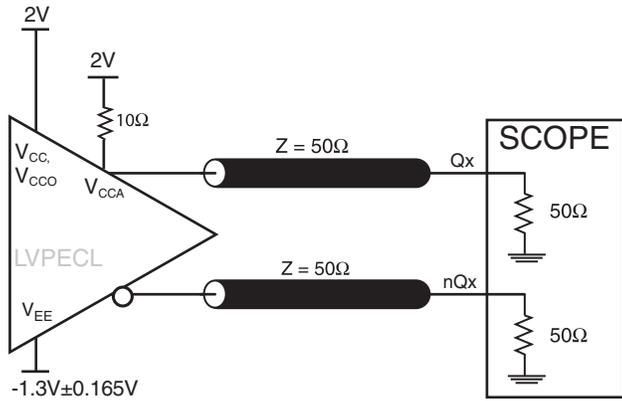
NOTE 1: Phase jitter using a crystal interface.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

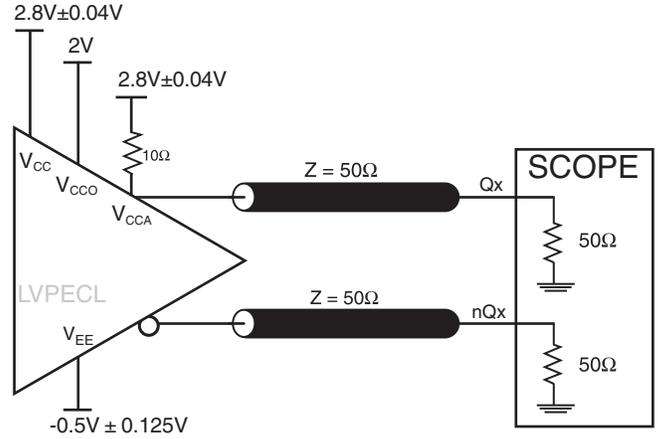
### TYPICAL PHASE NOISE AT 155.52MHz



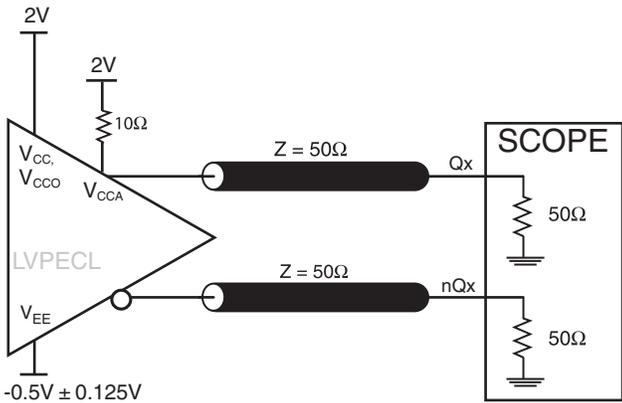
## PARAMETER MEASUREMENT INFORMATION



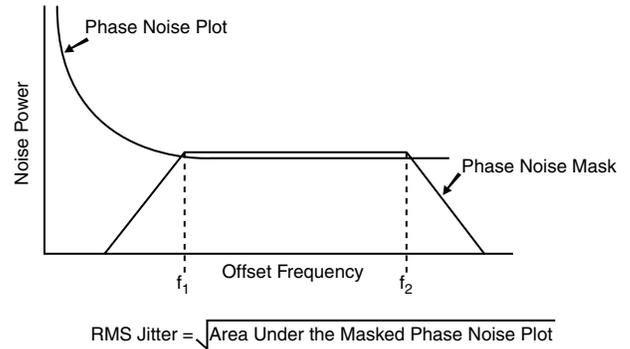
3.3V CORE/3.3V LVPECL OUTPUT LOAD AC TEST CIRCUIT



3.3V CORE/2.5V LVPECL OUTPUT LOAD AC TEST CIRCUIT



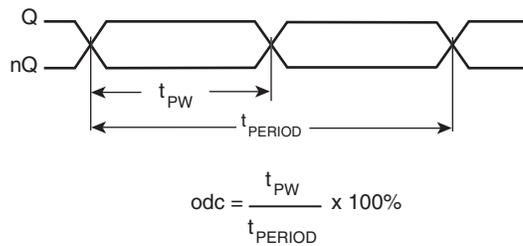
2.5V CORE/2.5V LVPECL OUTPUT LOAD AC TEST CIRCUIT



RMS PHASE JITTER



OUTPUT RISE/FALL TIME



OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

## APPLICATION INFORMATION

### POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. To achieve optimum jitter performance, power supply isolation is required. The ICS813321-04 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL.  $V_{CC}$ ,  $V_{CCA}$ , and  $V_{CCO}$  should be individually connected to the power supply plane through vias, and  $0.01\mu\text{F}$  bypass capacitors should be used for each pin. *Figure 1* illustrates this for a generic  $V_{CC}$  pin and also shows that  $V_{CCA}$  requires that an additional  $10\Omega$  resistor along with a  $10\mu\text{F}$  bypass capacitor be connected to the  $V_{CCA}$  pin.

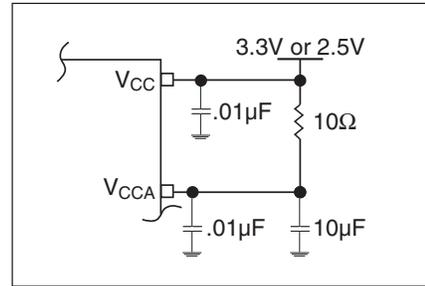


FIGURE 1. POWER SUPPLY FILTERING

### RECOMMENDATIONS FOR UNUSED INPUT PINS

#### INPUTS:

##### LVC MOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A  $1\text{k}\Omega$  resistor can be used.

### TERMINATION FOR 3.3V LVPECL OUTPUT

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are

designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 2A and 2B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

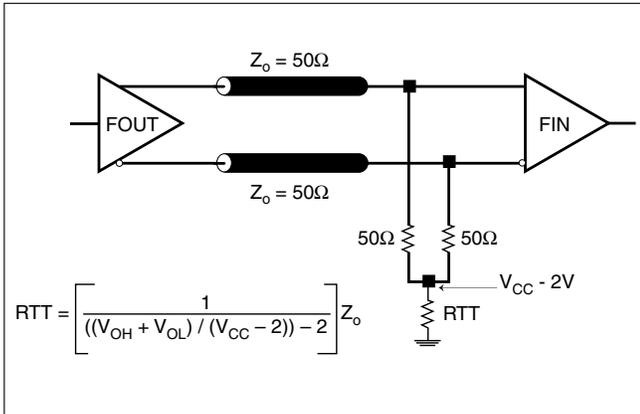


FIGURE 2A. LVPECL OUTPUT TERMINATION

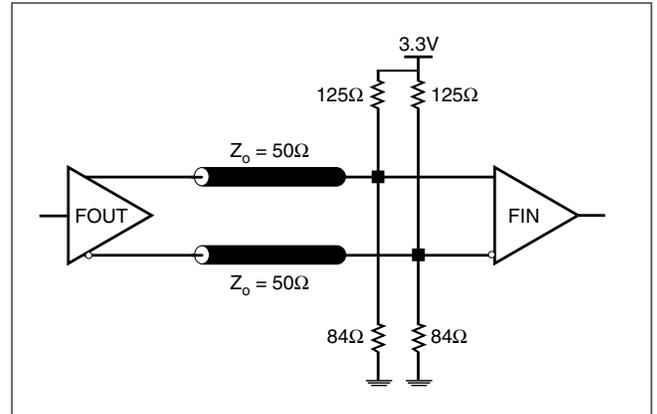
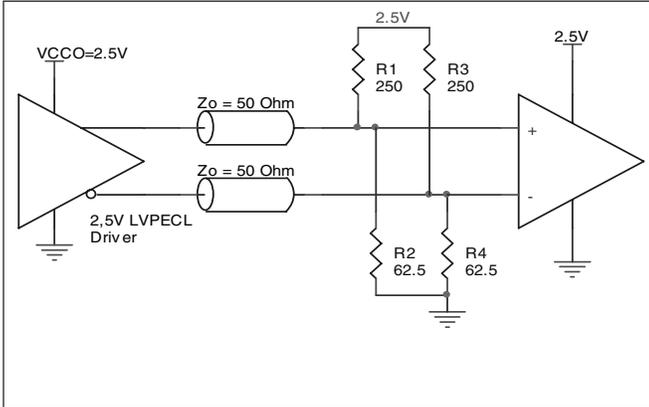


FIGURE 2B. LVPECL OUTPUT TERMINATION

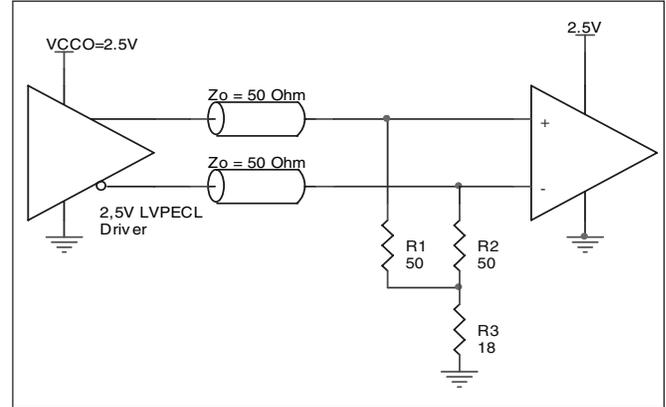
**TERMINATION FOR 2.5V LVPECL OUTPUT**

Figure 3A and Figure 3B show examples of termination for 2.5V LVPECL driver. These terminations are equivalent to terminating  $50\Omega$  to  $V_{cc} - 2V$ . For  $V_{cc} = 2.5V$ , the  $V_{cc} - 2V$  is very close to ground

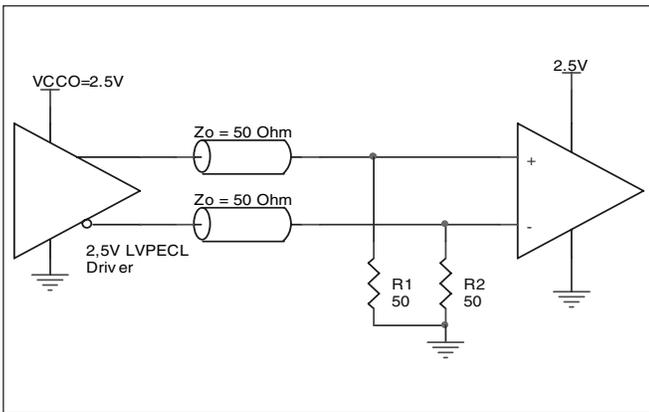
level. The R3 in Figure 3B can be eliminated and the termination is shown in Figure 3C.



**FIGURE 3A. 2.5V LVPECL DRIVER TERMINATION EXAMPLE**



**FIGURE 3B. 2.5V LVPECL DRIVER TERMINATION EXAMPLE**



**FIGURE 3C. 2.5V LVPECL TERMINATION EXAMPLE**

## VCXO CRYSTAL SELECTION

Choosing a crystal with the correct characteristics is one of the most critical steps in using a Voltage Controlled Crystal Oscillator (VCXO). The crystal parameters affect the tuning range and

accuracy of a VCXO. Below are the key variables and an example of using the crystal parameters to calculate the tuning range of the VCXO.

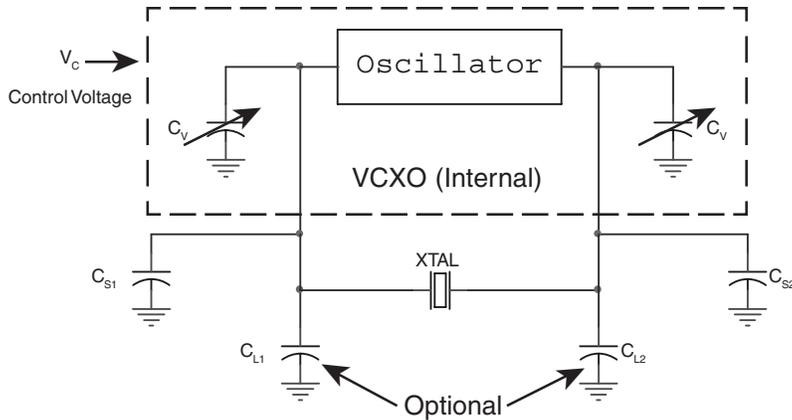


FIGURE 4. VCXO OSCILLATOR CIRCUIT

- $V_C$  - Control voltage used to tune frequency
- $C_V$  - Varactor capacitance, varies due to the change in control voltage
- $C_{L1}, C_{L2}$  - Load tuning capacitance used for fine tuning or centering nominal frequency
- $C_{S1}, C_{S2}$  - Stray Capacitance caused by pads, vias, and other board parasitics

TABLE 6. EXAMPLE CRYSTAL PARAMETERS

| Symbol     | Parameter                    | Test Conditions | Minimum     | Typical | Maximum | Units |
|------------|------------------------------|-----------------|-------------|---------|---------|-------|
| $f_N$      | Nominal Frequency            |                 | 14          |         | 20      | MHz   |
| $f_T$      | Frequency Tolerance          |                 |             |         | ±20     | ppm   |
| $f_S$      | Frequency Stability          |                 |             |         | ±20     | ppm   |
|            | Operating Temperature Range  |                 | 0           |         | 70      | °C    |
| $C_L$      | Load Capacitance             |                 |             | 12      |         | pF    |
| $C_O$      | Shunt Capacitance            |                 |             | 4       |         | pF    |
| $C_1, C_2$ | Pullability Ratio            |                 |             | 220     | 240     |       |
| ESR        | Equivalent Series Resistance |                 |             |         | 20      |       |
|            | Drive Level                  |                 |             |         | 1       | mW    |
|            | Aging @ 25°C                 |                 | ±3 per year |         |         | ppm   |
|            | Mode of Operation            |                 | Fundamental |         |         |       |

TABLE 7. VARACTOR PARAMETERS

| Symbol        | Parameter                 | Test Conditions | Minimum | Typical | Maximum | Units |
|---------------|---------------------------|-----------------|---------|---------|---------|-------|
| $C_{V\_LOW}$  | Low Varactor Capacitance  | $V_C = 0V$      |         | 6       |         | pF    |
| $C_{V\_HIGH}$ | High Varactor Capacitance | $V_C = 3.3V$    |         | 11      |         | pF    |

## FORMULAS

$$C_{Low} = \frac{(C_{L1} + C_{S1} + C_{V\_Low}) \cdot (C_{L2} + C_{S2} + C_{V\_Low})}{(C_{L1} + C_{S1} + C_{V\_Low}) + (C_{L2} + C_{S2} + C_{V\_Low})}$$

$$C_{High} = \frac{(C_{L1} + C_{S1} + C_{V\_High}) \cdot (C_{L2} + C_{S2} + C_{V\_High})}{(C_{L1} + C_{S1} + C_{V\_High}) + (C_{L2} + C_{S2} + C_{V\_High})}$$

- $C_{Low}$  is the effective capacitance due to the low varactor capacitance, load capacitance and stray capacitance.  $C_{Low}$  determines the high frequency component on the TPR.
- $C_{High}$  is the effective capacitance due to the high varactor capacitance, load capacitance and stray capacitance.  $C_{High}$  determines the low frequency component on the TPR.

$$Total\ Pull\ Range\ (TPR) = \left( \frac{1}{2 \cdot C_0 / C_1 \cdot \left(1 + C_{Low} / C_0\right)} - \frac{1}{2 \cdot C_0 / C_1 \cdot \left(1 + C_{High} / C_0\right)} \right) \cdot 10^6$$

Absolute Pull Range (APR) = Total Pull Range – (Frequency Tolerance + Frequency Stability + Aging)

## EXAMPLE CALCULATIONS

Using the tables and figures above, we can now calculate the TPR and APR of the VCXO using the example crystal parameters. For the numerical example below there were some assumptions made. First, the stray capacitance ( $C_{S1}$ ,  $C_{S2}$ ), which is all the excess capacitance due to board parasitic, is 4pF. Second, the expected lifetime of the project is 5 years; hence the inaccuracy due to

aging is ±15ppm. Third, though many boards will not require load tuning capacitors ( $C_{L1}$ ,  $C_{L2}$ ), it is recommended for long-term consistent performance of the system that two tuning capacitor pads be placed into every design. Typical values for the load tuning capacitors will range from 0 to 4pF.

$$C_{Low} = \frac{(0 + 4pf + 15pf) \cdot (0 + 4pf + 15pf)}{(0 + 4pf + 15pf) + (0 + 4pf + 15pf)} = 9.5pf$$

$$C_{High} = \frac{(0 + 4pf + 27.4pf) \cdot (0 + 4pf + 27.4pf)}{(0 + 4pf + 27.4pf) + (0 + 4pf + 27.4pf)} = 15.7pf$$

$$TPR = \left( \frac{1}{2 \cdot 220 \cdot \left(1 + 9.5pf / 4pf\right)} - \frac{1}{2 \cdot 220 \cdot \left(1 + 15.7pf / 4pf\right)} \right) \cdot 10^6 = 212ppm$$

TPR = ±106ppm

APR = 106ppm – (20ppm + 20ppm + 15ppm) = ±51ppm

The example above will ensure a total pull range of ±106 ppm with an APR of ±51ppm. Many times, board designers may select their own crystal based on their application. If the application requires a tighter APR, a crystal with better pullability

(C0/C1 ratio) can be used. Also, with the equations above, one can vary the frequency tolerance, temperature stability, and aging or shunt capacitance to achieve the required pullability.

## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS813321-04. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the ICS813321-04 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for  $V_{CC} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

**NOTE:** Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> =  $V_{CC\_MAX} * I_{EE\_MAX} = 3.465V * 130mA = 450mW$

**Total Power**<sub>MAX</sub> (3.465V, with output switching) = 450mW + 30mW = **480mW**

### 2. Junction Temperature.

Junction temperature, T<sub>j</sub>, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for T<sub>j</sub> is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

T<sub>j</sub> = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

Pd<sub>total</sub> = Total Device Power Dissipation (example calculation is in section 1 above)

T<sub>A</sub> = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming no air flow and a multi-layer board, the appropriate value is 92.4°C/W per Table 8 below.

Therefore, T<sub>j</sub> for an ambient temperature of 70°C with all outputs switching is:  
70°C + 0.480W \* 92.4°C/W = 114.4°C. This is below the limit of 125°C.

This calculation is only an example. T<sub>j</sub> will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 8. THERMAL RESISTANCE  $\theta_{JA}$  FOR 16-PIN TSSOP, FORCED CONVECTION**

| $\theta_{JA}$ by Velocity (Meters per Second) |          |          |           |
|---|----------|----------|-----------|
|   | 0        | 1        | 2.5       |
| Multi-Layer PCB, JEDEC Standard Test Boards   | 92.4°C/W | 88.0°C/W | 75.91°C/W |

3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load. LVPECL output driver circuit and termination are shown in Figure 5.

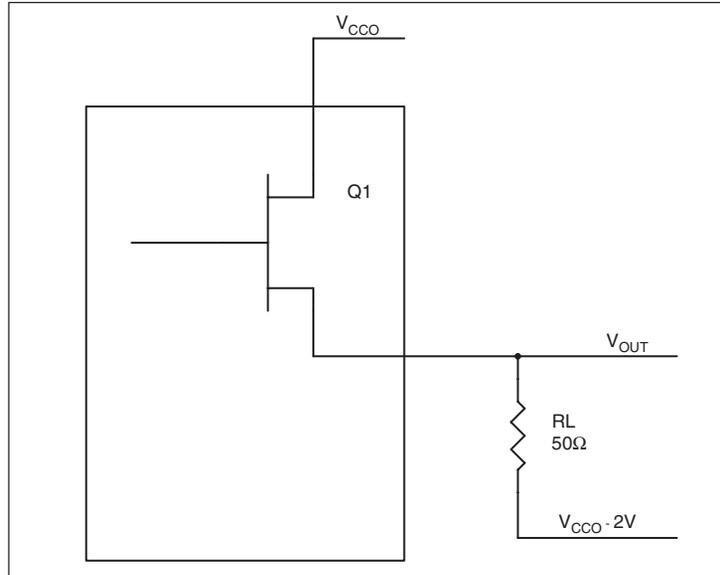


FIGURE 5. LVPECL DRIVER CIRCUIT AND TERMINATION

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of  $V_{CCO} - 2V$ .

- For logic high,  $V_{OUT} = V_{OH\_MAX} = V_{CCO\_MAX} - 0.9V$

$$(V_{CCO\_MAX} - V_{OH\_MAX}) = 0.9V$$

- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CCO\_MAX} - 1.7V$

$$(V_{CCO\_MAX} - V_{OL\_MAX}) = 1.7V$$

$Pd\_H$  is power dissipation when the output drives high.

$Pd\_L$  is the power dissipation when the output drives low.

$$Pd\_H = [(V_{OH\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CCO\_MAX} - 2V))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair =  $Pd\_H + Pd\_L = 30mW$

## RELIABILITY INFORMATION

TABLE 9.  $\theta_{JA}$  vs. AIR FLOW TABLE FOR 16 LEAD TSSOP

| $\theta_{JA}$ by Velocity (Meters per Second) |          |          |           |
|---|----------|----------|-----------|
|   | 0        | 1        | 2.5       |
| Multi-Layer PCB, JEDEC Standard Test Boards   | 92.4°C/W | 88.0°C/W | 75.91°C/W |

### TRANSISTOR COUNT

The transistor count for ICS813321-04 is: 3948

PACKAGE OUTLINE - G SUFFIX FOR 16 LEAD TSSOP

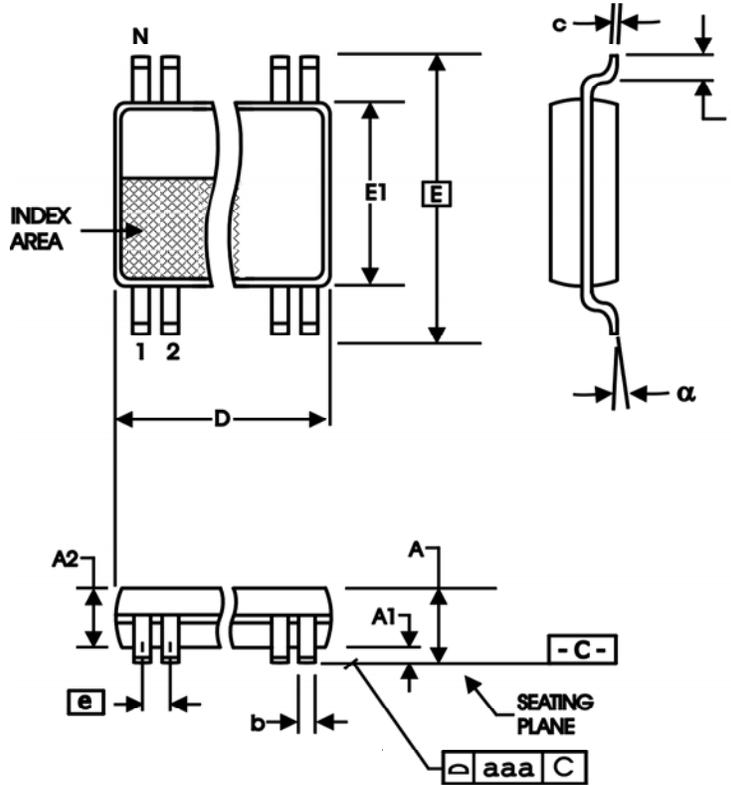


TABLE 10. PACKAGE DIMENSIONS

| SYMBOL | Millimeters |         |
|--------|-------------|---------|
|        | Minimum     | Maximum |
| N      | 16          |         |
| A      | --          | 1.20    |
| A1     | 0.05        | 0.15    |
| A2     | 0.80        | 1.05    |
| b      | 0.19        | 0.30    |
| c      | 0.09        | 0.20    |
| D      | 4.90        | 5.10    |
| E      | 6.40 BASIC  |         |
| E1     | 4.30        | 4.50    |
| e      | 0.65 BASIC  |         |
| L      | 0.45        | 0.75    |
| α      | 0°          | 8°      |
| aaa    | --          | 0.10    |

Reference Document: JEDEC Publication 95, MO-153

**TABLE 11. ORDERING INFORMATION**

| <b>Part/Order Number</b> | <b>Marking</b> | <b>Package</b>            | <b>Shipping Packaging</b> | <b>Temperature</b> |
|--------------------------|----------------|---------------------------|---------------------------|--------------------|
| ICS813321AG-04           | 13321A04       | 16 lead TSSOP             | tube                      | 0°C to 70°C        |
| ICS813321AG-04T          | 13321A04       | 16 lead TSSOP             | 2500 tape & reel          | 0°C to 70°C        |
| ICS813321AG-04LF         | 3321A04L       | 16 lead "Lead-Free" TSSOP | tube                      | 0°C to 70°C        |
| ICS813321AG-04LFT        | 3321A04L       | 16 lead "Lead-Free" TSSOP | 2500 tape & reel          | 0°C to 70°C        |

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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